

Title: APPARATUS WITH RESOLUTION ENHANCEMENT FEATURE FOR
IMPROVING ACCURACY OF CONVERSION OF REQUIRED CHEMICAL MECHANICAL
POLISHING PRESSURE TO FORCE TO BE APPLIED BY POLISHING HEAD TO WAFER
Inventor: Miguel A. Saldana Docket No. LAM2P255D2 Filing Date: February 26, 2004

Fig. 1A

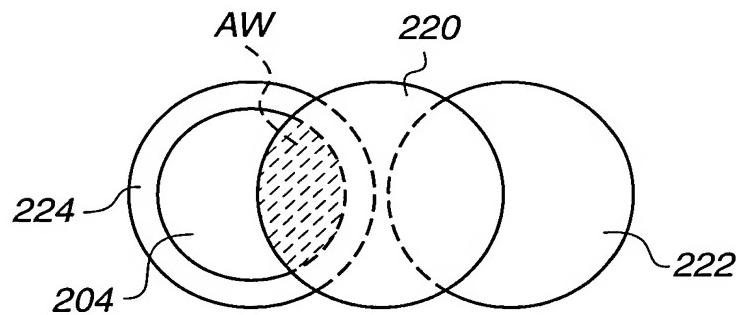
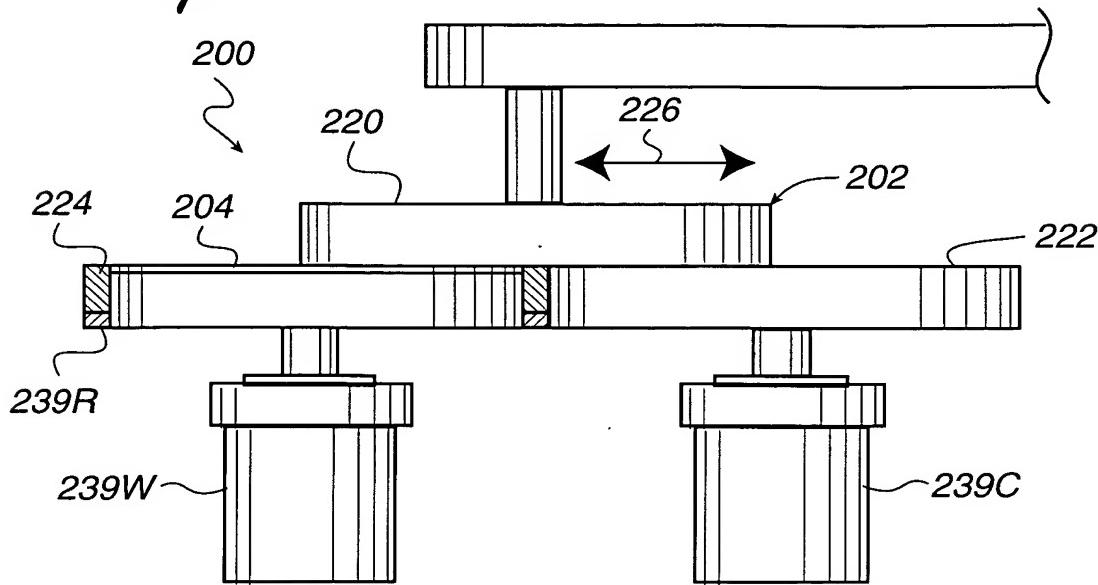


Fig. 1B

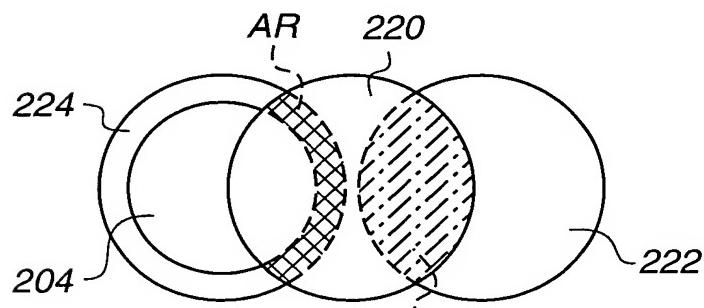
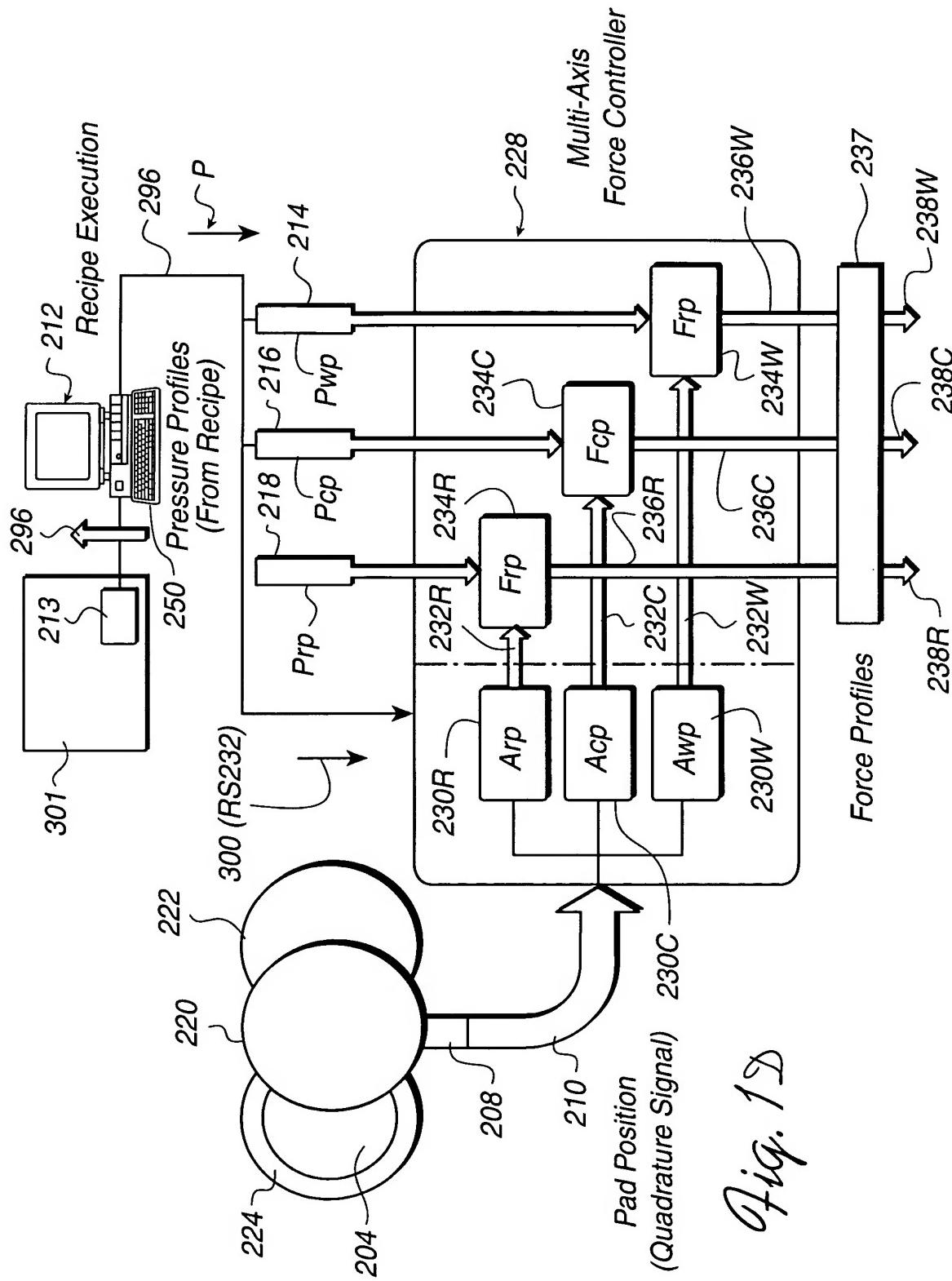


Fig. 1C



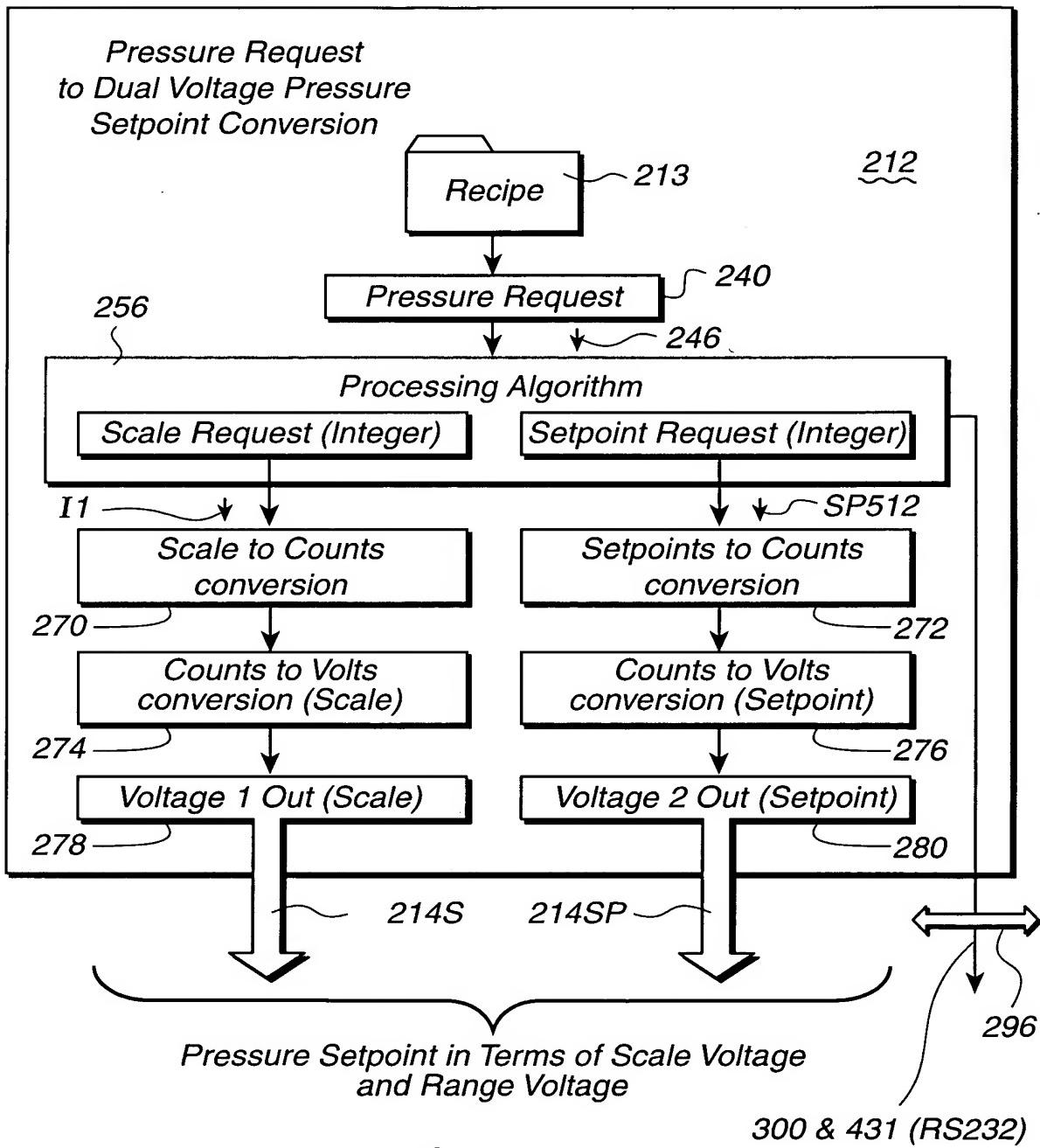


Fig. 2

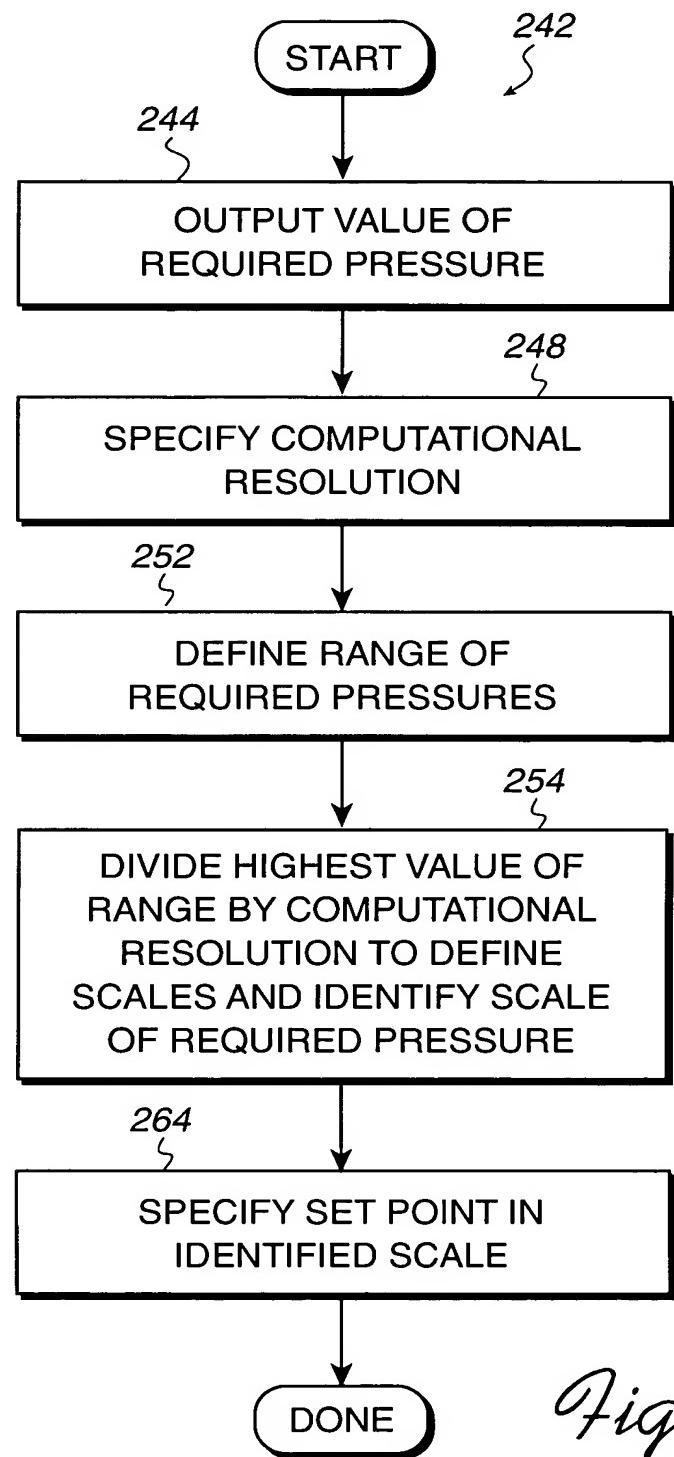


Fig. 3

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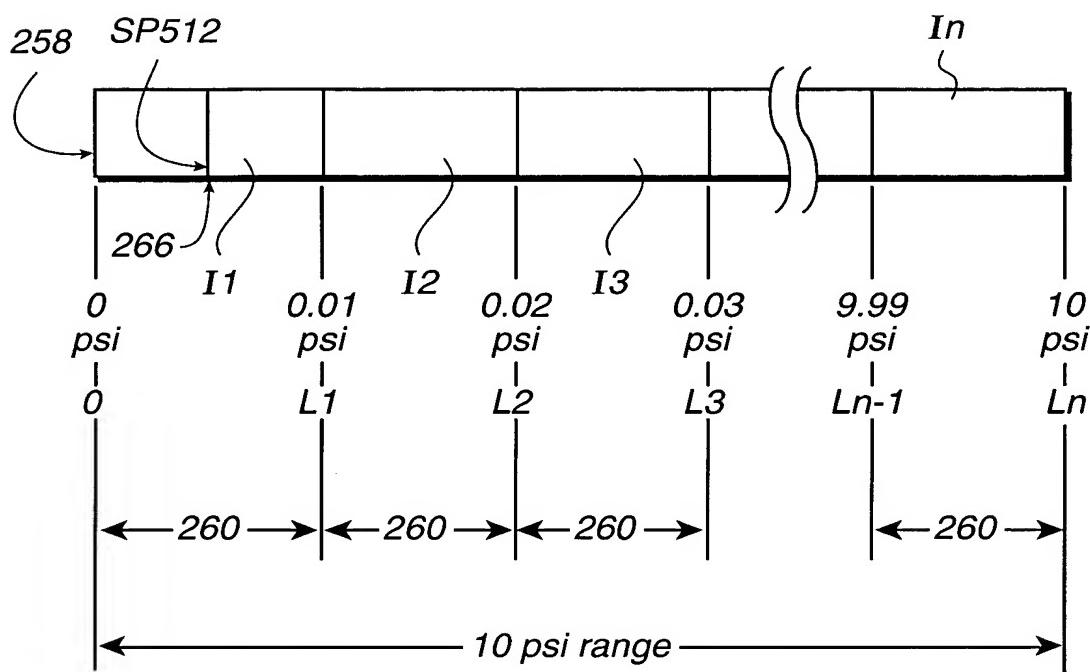


Fig. 4

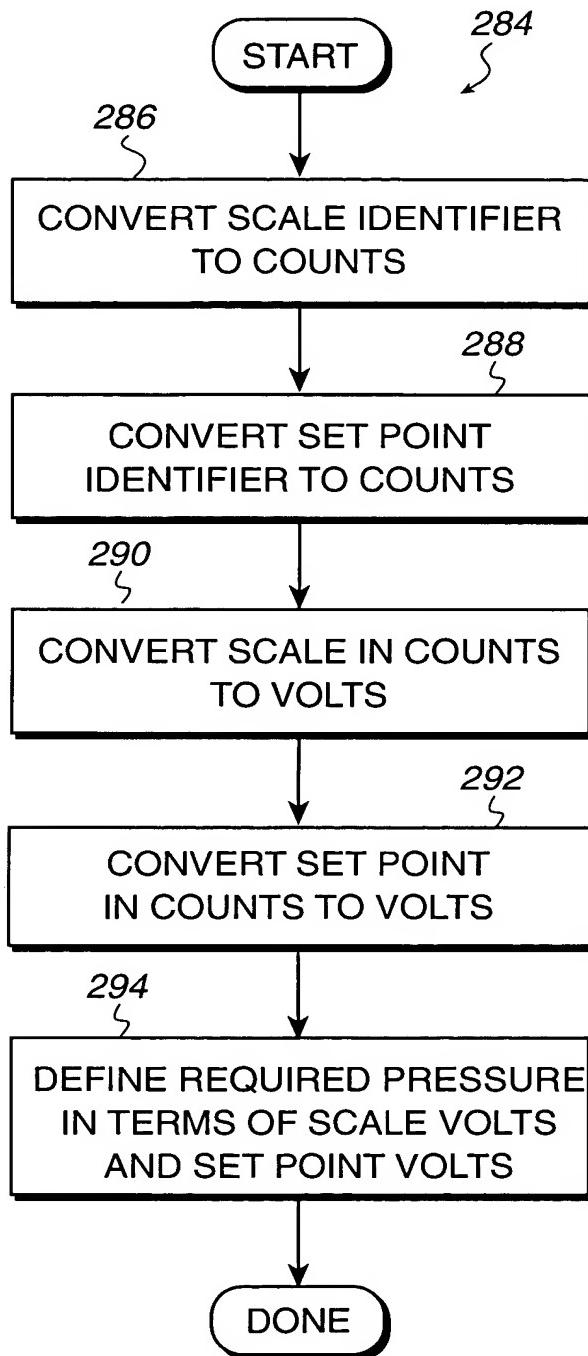


Fig. 5

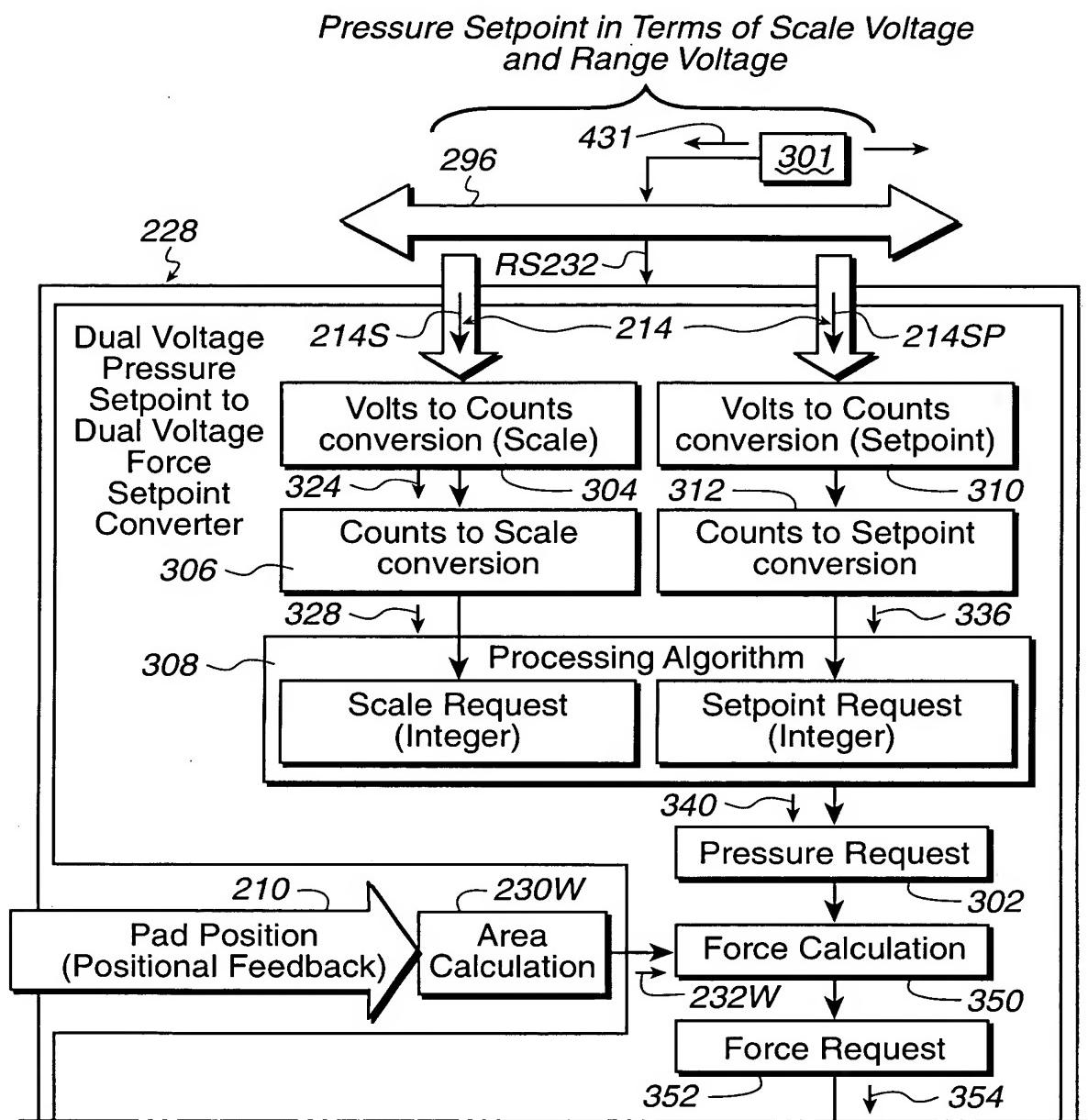


Fig. 6

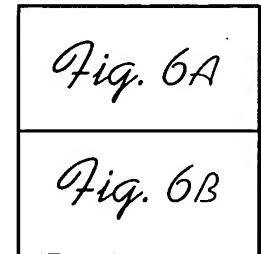


Fig. 6A

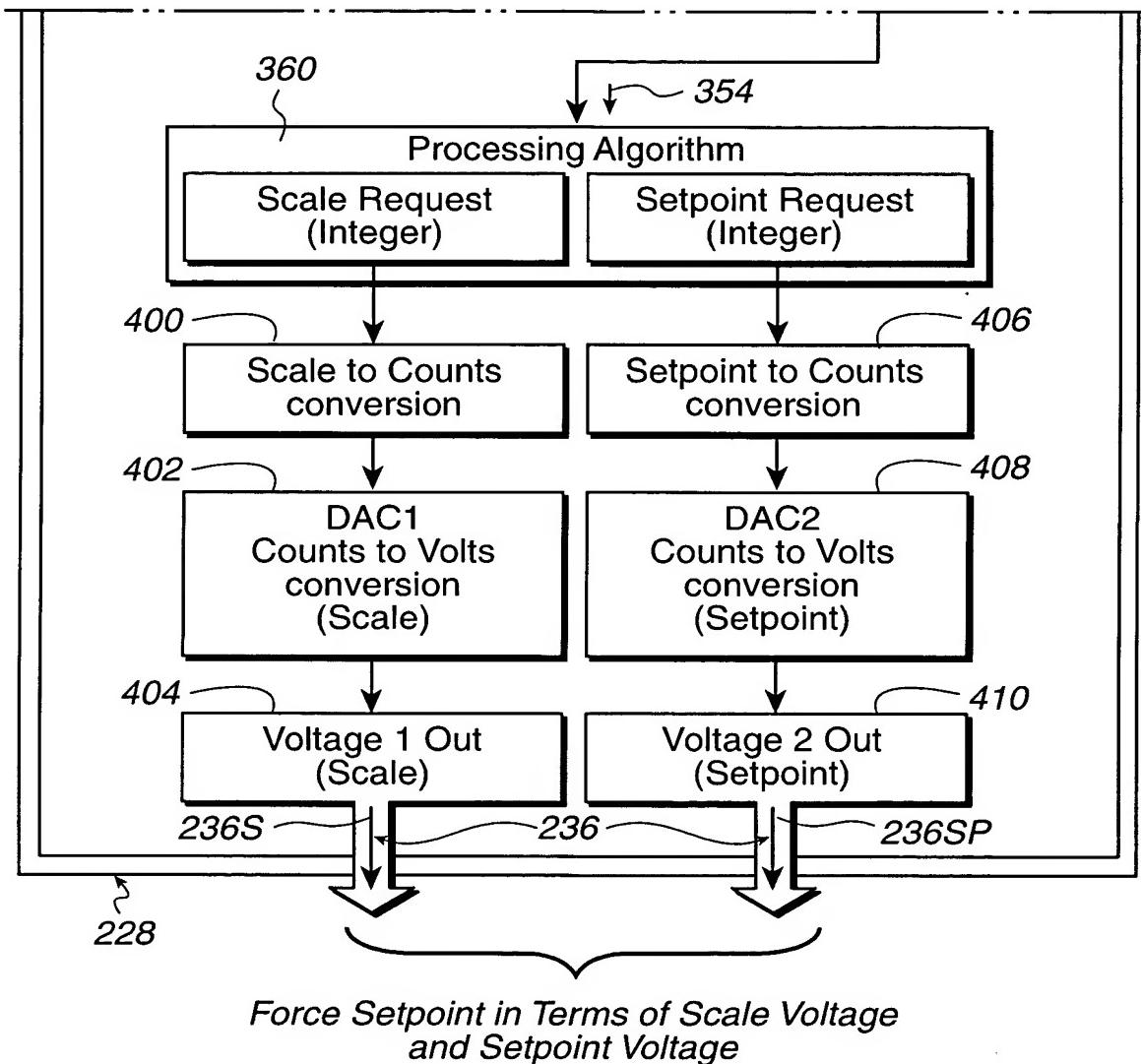


Fig. 6B

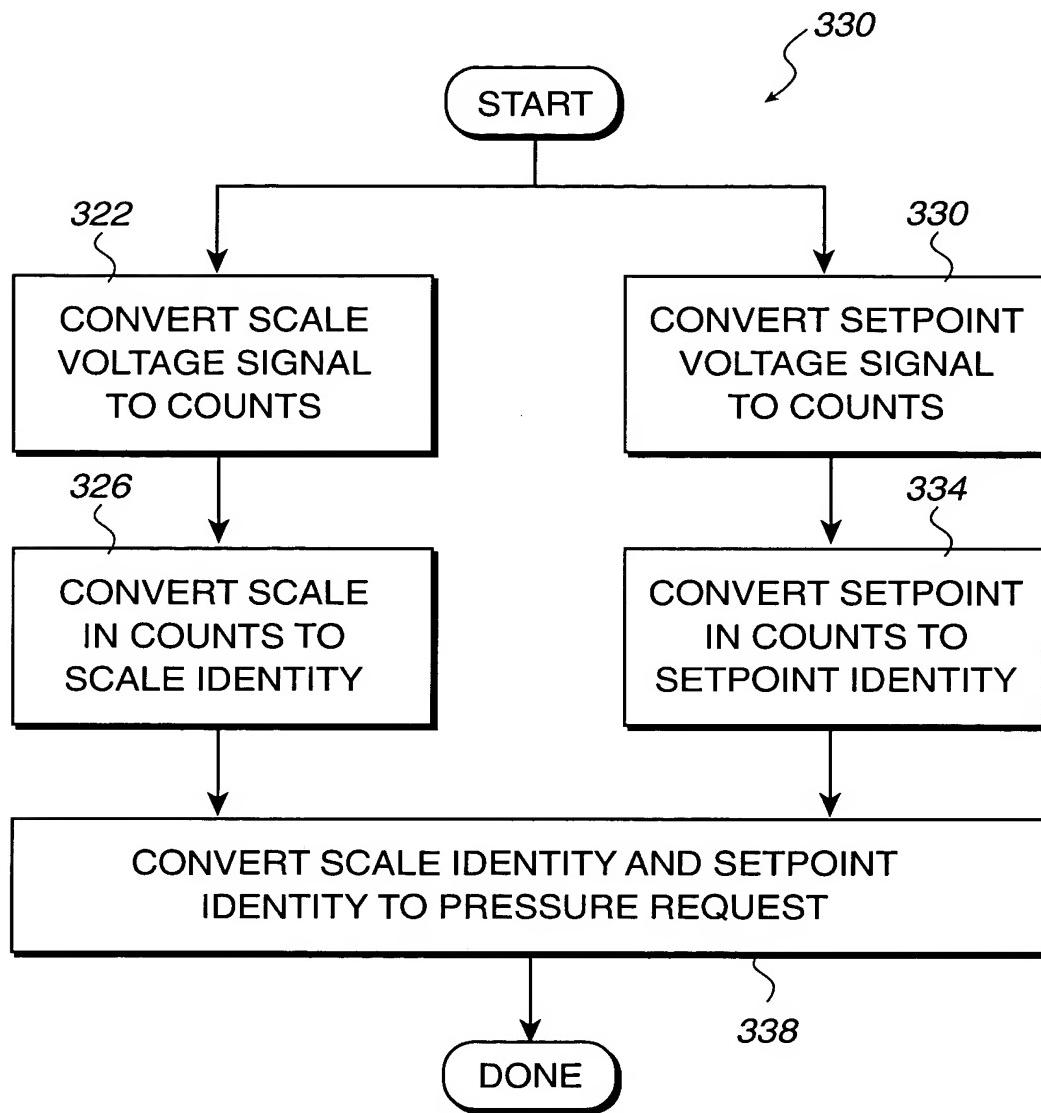


Fig. 7

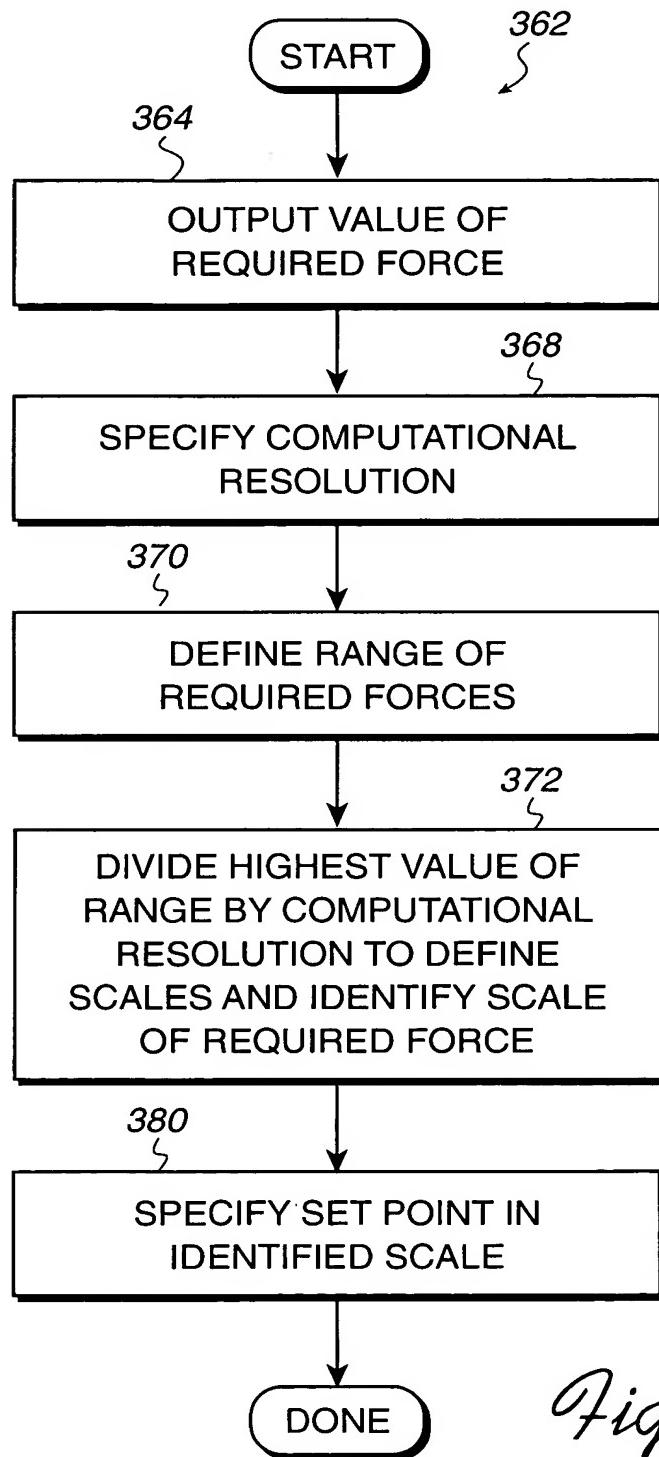


Fig. 8

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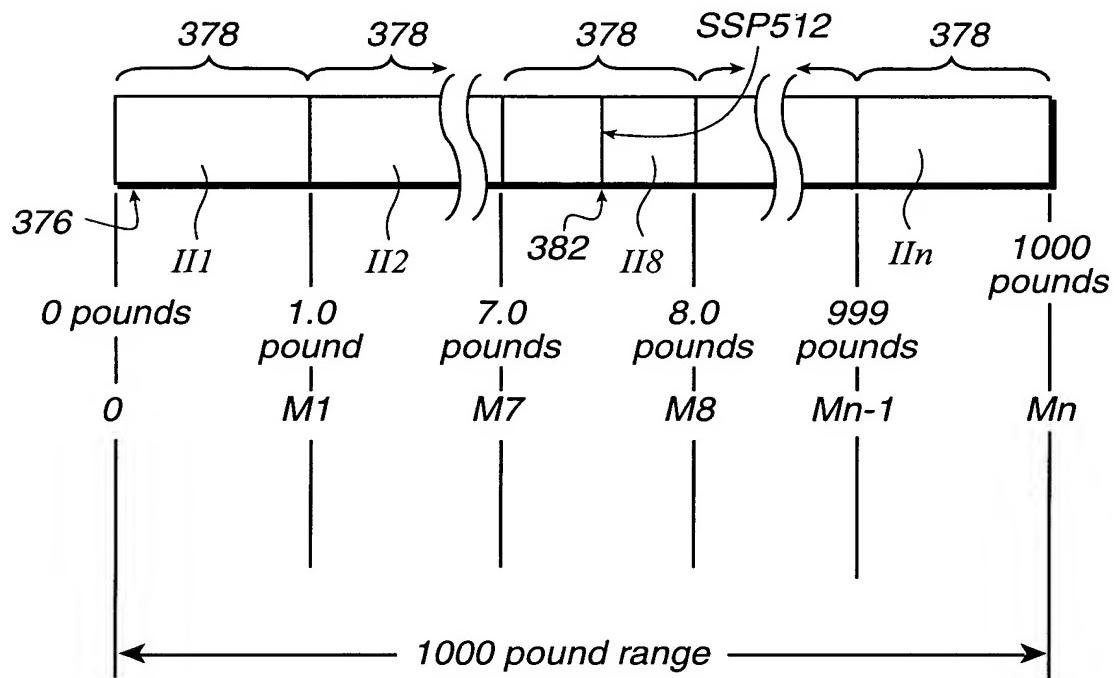


Fig. 9

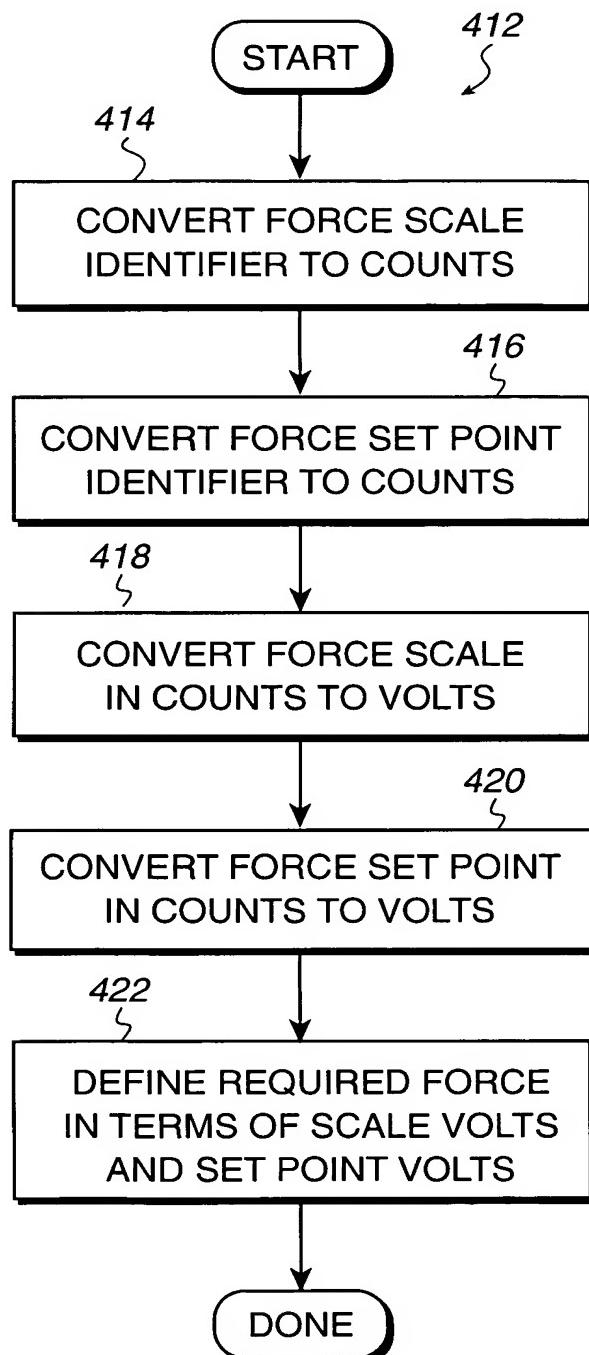
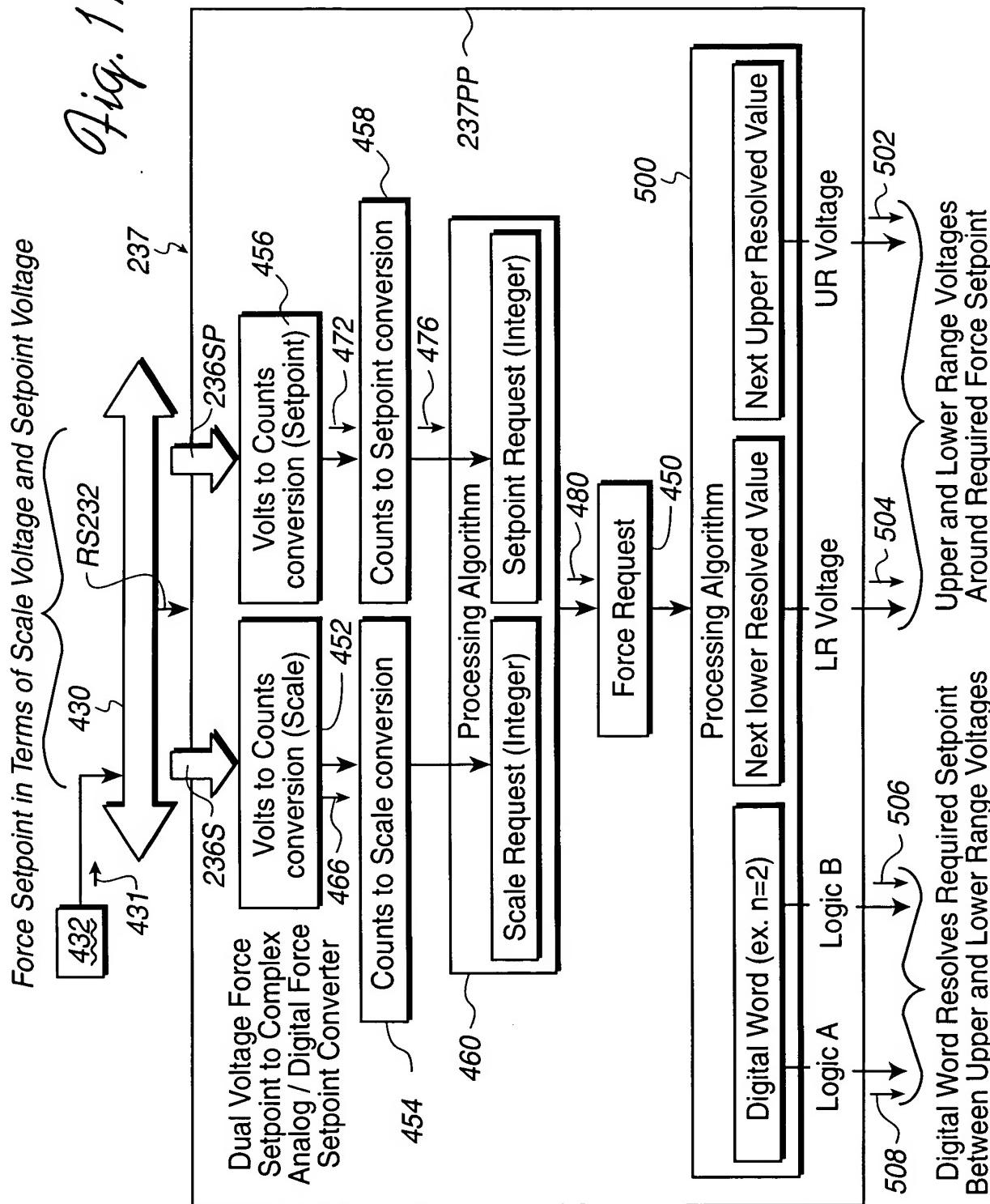
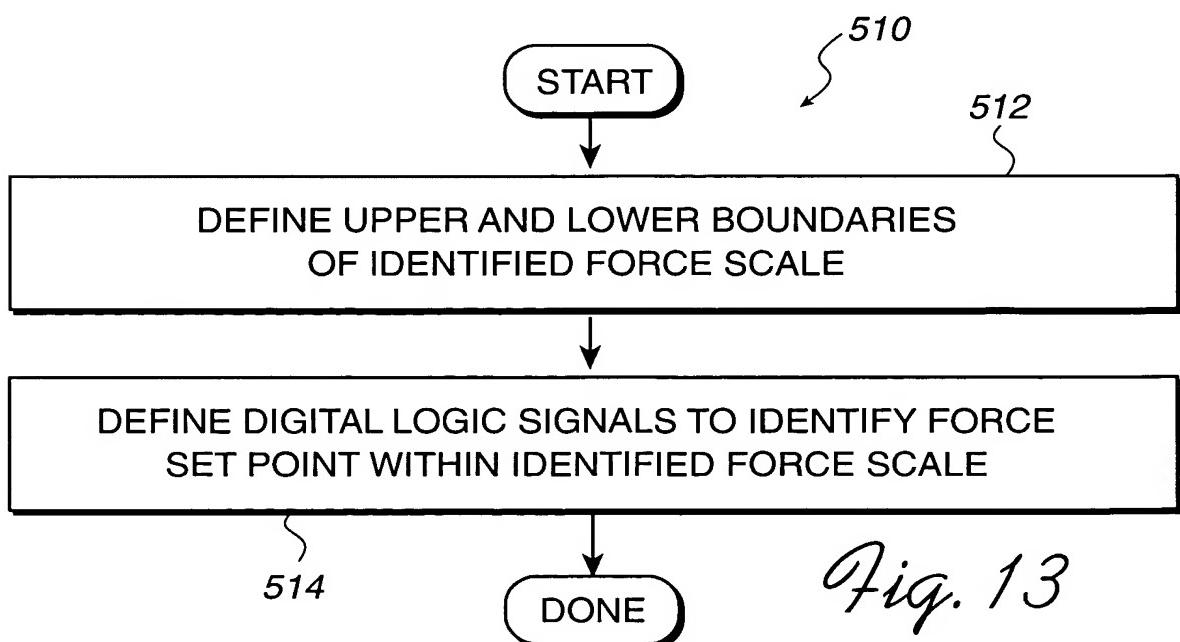
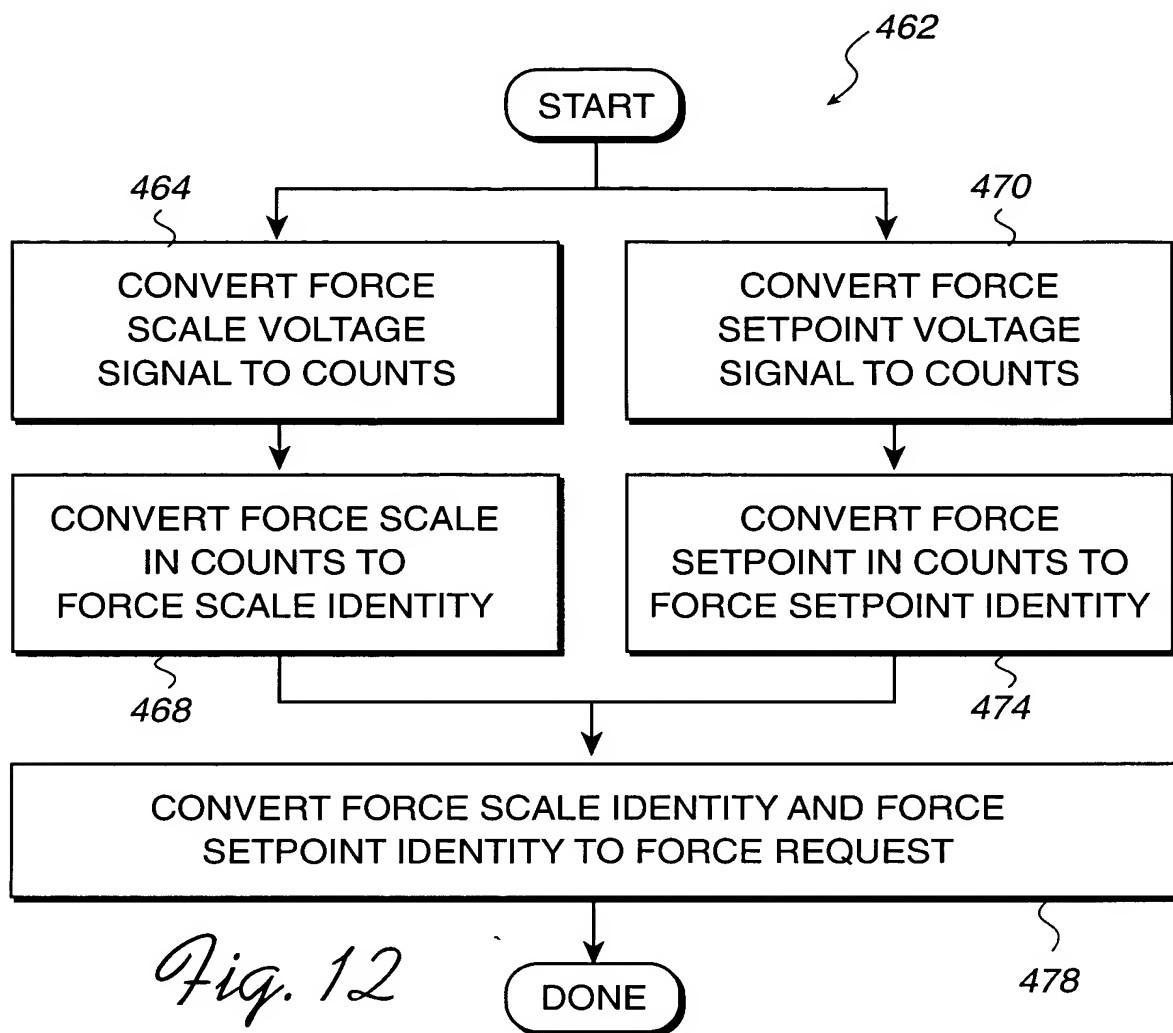
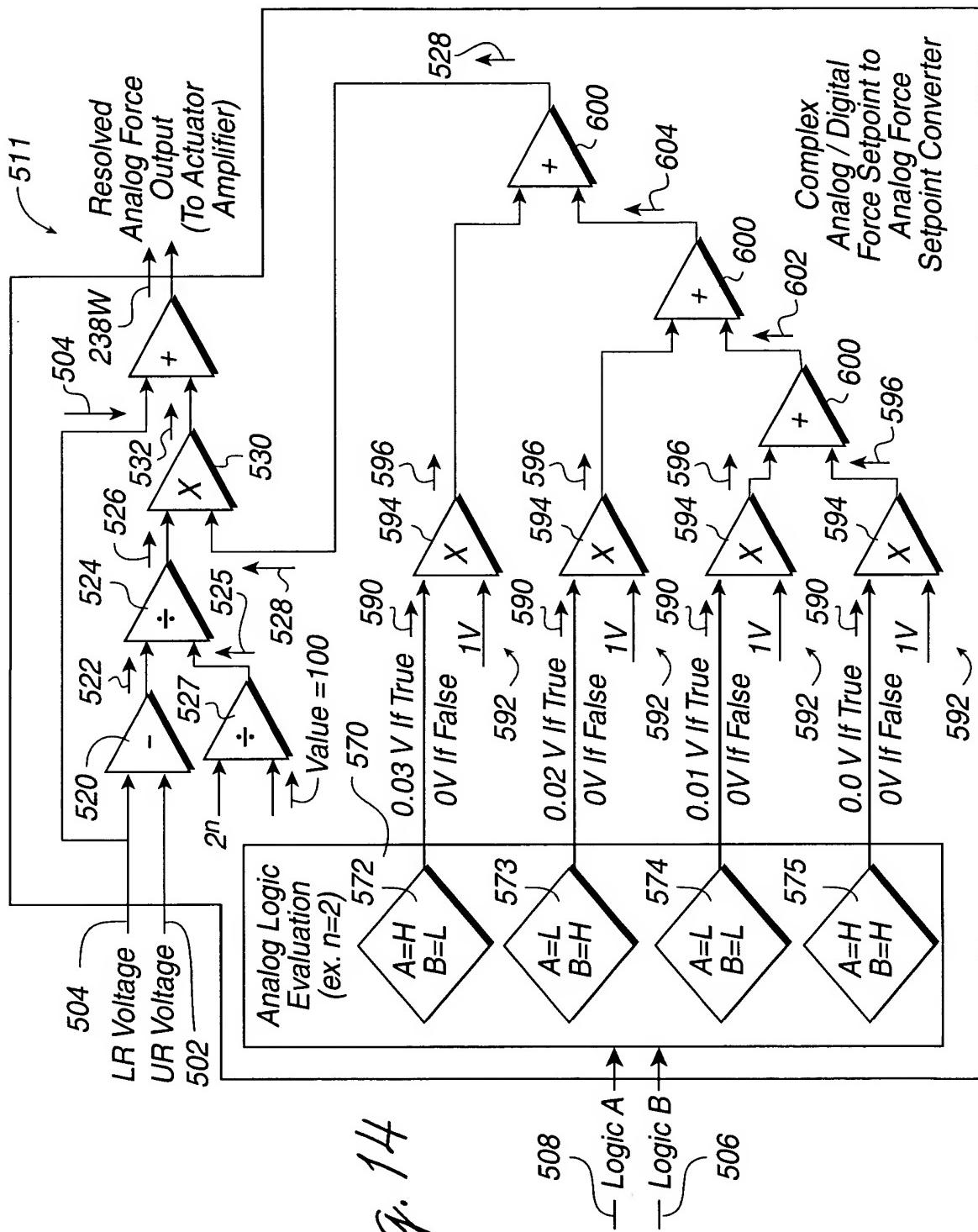


Fig. 10

Fig. 11







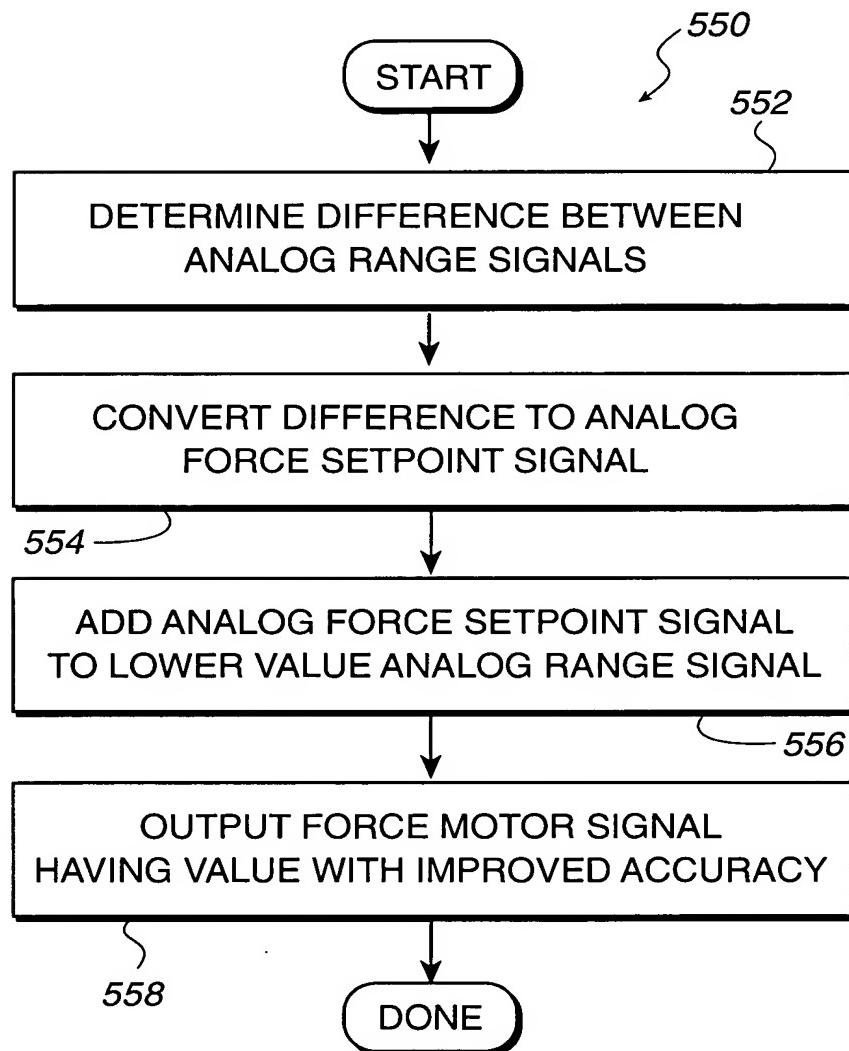


Fig. 15